

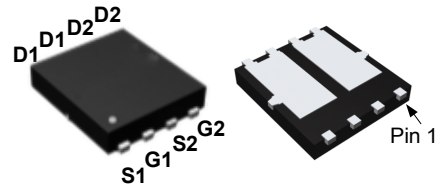
Features

- N Channel**
 30V/15A,
 $R_{DS(ON)} = 10m\Omega$ (typ.) @ $V_{GS} = 10V$
 $R_{DS(ON)} = 17m\Omega$ (typ.) @ $V_{GS} = 4.5V$
- P Channel**
 -30V/-15A,
 $R_{DS(ON)} = 25m\Omega$ (typ.) @ $V_{GS} = -10V$
 $R_{DS(ON)} = 34m\Omega$ (typ.) @ $V_{GS} = -4.5V$
- 100% UIS + R_g Tested
- Reliable and Rugged
- Lead Free Available (RoHS Compliant)
- Moisture Sensitivity Level MSL1
(per JEDEC J-STD-020D)

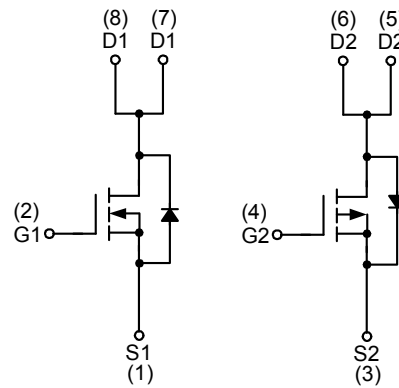
Applications

- Synchronous Rectification.
- Motor Control.
- High Current, High Speed Switching.
- Portable equipment application.

Pin Description



PDFN5*6-8L



N-Channel MOSFET

P-Channel MOSFET

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | N Channel | P Channel | Unit | |
|-----------------------|---|-------------------------|-----------|------------------|--------------------|
| Common Ratings | | | | | |
| V_{DSS} | Drain-Source Voltage | 30 | -30 | V | |
| V_{GSS} | Gate-Source Voltage | ± 20 | ± 25 | | |
| T_J | Maximum Junction Temperature | 150 | | $^\circ\text{C}$ | |
| T_{STG} | Storage Temperature Range | -55 to 150 | | | |
| I_S | Diode Continuous Forward Current | $T_C=25^\circ\text{C}$ | 15 | -15 | A |
| I_D | Continuous Drain Current(Wire Bond Limited) | $T_C=25^\circ\text{C}$ | 15 | -15 | A |
| | | $T_C=100^\circ\text{C}$ | 6 | -6 | |
| P_D | Maximum Power Dissipation | $T_C=25^\circ\text{C}$ | 19 | 19 | W |
| | | $T_C=100^\circ\text{C}$ | 7.7 | 7.7 | |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case | Steady State | 6.5 | 6.5 | $^\circ\text{C/W}$ |
| I_D | Continuous Drain Current | $T_A=25^\circ\text{C}$ | 9.3 | -6.8 | A |
| | | $T_A=70^\circ\text{C}$ | 7.4 | -5.4 | |
| I_{DM}^a | Pulsed Drain Current | $T_A=25^\circ\text{C}$ | 37 | -28 | A |
| P_D | Maximum Power Dissipation | $T_A=25^\circ\text{C}$ | 1.42 | 1.42 | W |
| | | $T_A=70^\circ\text{C}$ | 0.9 | 0.9 | |
| $R_{\theta JA}^b$ | Thermal Resistance-Junction to Ambient | $t \leq 10\text{s}$ | 45 | 45 | $^\circ\text{C/W}$ |
| | | Steady State | 88 | 88 | $^\circ\text{C/W}$ |
| I_{AS}^c | Avalanche Current, Single pulse | $L=0.1\text{mH}$ | 23 | -24 | A |
| E_{AS}^c | Avalanche Energy, Single pulse | $L=0.1\text{mH}$ | 26.45 | -28.8 | mJ |

Note a : Max. continuous current is limited by bonding wire.

Note b : Pulse width limited by max. junction temperature.

Note c : Surface Mounted on 1in^2 pad area, steady state $t = 999\text{s}$.

Note d : UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature $T_J=25^\circ\text{C}$)

N Channel Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | N Channel | | | Unit |
|--|----------------------------------|---|-----------|------------|-----------|------------|
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_{DS}=250\mu A$ | 30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=24V, V_{GS}=0V$ $T_J=85^\circ\text{C}$ | - | - | 1 30 | μA |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_{DS}=250\mu A$ | 1.5 | 1.8 | 2.5 | V |
| I_{GSS} | Gate Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| $R_{DS(ON)}^e$ | Drain-Source On-state Resistance | $V_{GS}=10V, I_{DS}=8A$ $T_J=125^\circ\text{C}$ | - | 10 13.9 | 13 - | m Ω |
| | | $V_{GS}=4.5V, I_{DS}=5A$ | - | 17 | 19 | |
| Gfs | Forward Transconductance | $V_{DS}=5V, I_{DS}=5A$ | - | 15 | - | S |
| Diode Characteristics | | | | | | |
| V_{SD}^e | Diode Forward Voltage | $I_{SD}=3A, V_{GS}=0V$ | - | 0.75 | 1.1 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD}=8A, dI_{SD}/dt=100A/\mu s$ | - | 11.7 | - | ns |
| t_a | Charge Time | | - | 4.8 | - | |
| t_b | Discharge Time | | - | 6.9 | - | |
| Q_{rr} | Reverse Recovery Charge | | - | 1.7 | - | nC |
| Dynamic Characteristics^f | | | | | | |
| R_G | Gate Resistance | $V_{GS}=0V, V_{DS}=0V, f=1\text{MHz}$ | - | 0.9 | - | Ω |
| C_{iss} | Input Capacitance | $V_{GS}=0V,$ $V_{DS}=15V,$ Frequency=1.0MHz | - | 940 | - | pF |
| C_{oss} | Output Capacitance | | - | 150 | - | |
| C_{rss} | Reverse Transfer Capacitance | | - | 100 | - | |
| $t_{d(ON)}$ | Turn-on Delay Time | $V_{DD}=15V, R_L=15\Omega,$ $I_{DS}=1A, V_{GEN}=10V,$ $R_G=1\Omega$ | - | 11.9 | - | ns |
| t_r | Turn-on Rise Time | | - | 10.1 | - | |
| $t_{d(OFF)}$ | Turn-off Delay Time | | - | 22 | - | |
| t_f | Turn-off Fall Time | | - | 5 | - | |
| Gate Charge Characteristics^f | | | | | | |
| Q_g | Total Gate Charge | $V_{DS}=15V, V_{GS}=4.5V,$ $I_{DS}=8A$ | - | 8.7 | - | nC |
| Q_g | Total Gate Charge | $V_{DS}=15V, V_{GS}=10V,$ $I_{DS}=8A$ | - | 18 | - | |
| Q_{gth} | Threshold Gate Charge | | - | 1.24 | - | |
| Q_{gs} | Gate-Source Charge | | - | 2 | - | |
| Q_{gd} | Gate-Drain Charge | | - | 4 | - | |

 Note e : Pulse test ; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

Note f : Guaranteed by design, not subject to production testing.

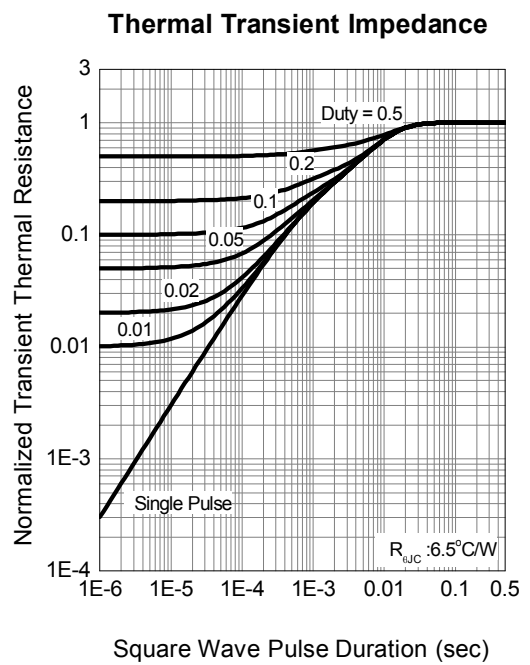
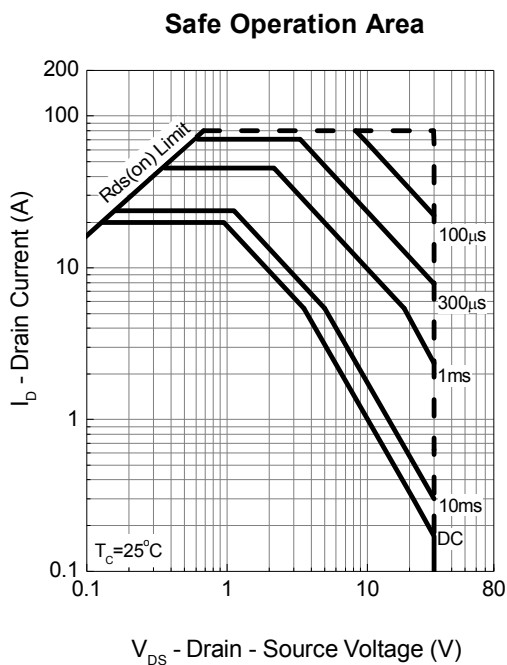
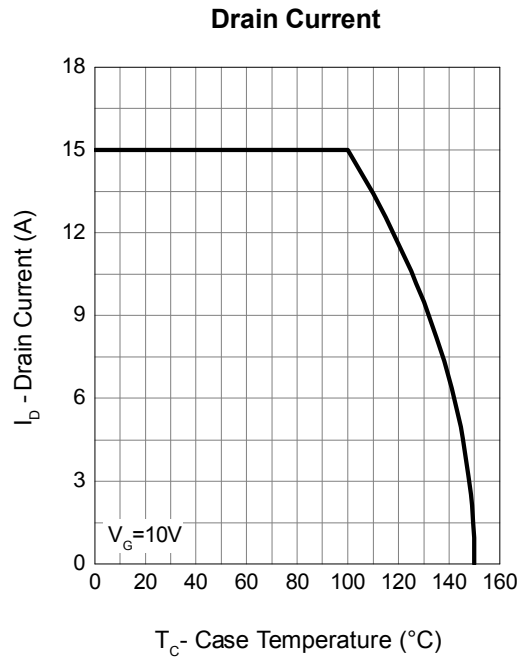
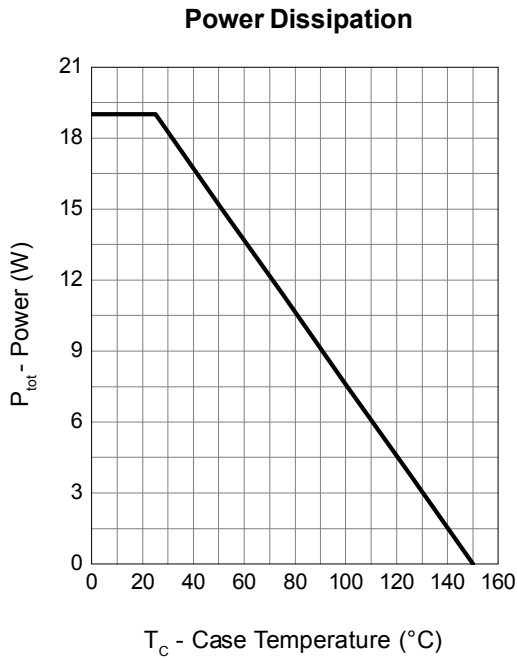
P Channel Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | P Channel | | | Unit |
|--|----------------------------------|--|-----------|-------|-----------|------------|
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_{DS}=-250\mu A$ | -30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=-24V, V_{GS}=0V$ | - | - | -1 | μA |
| | | $T_J=85^\circ\text{C}$ | - | - | -30 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_{DS}=-250\mu A$ | -1.5 | -2 | -2.5 | V |
| I_{GSS} | Gate Leakage Current | $V_{GS}=\pm 25V, V_{DS}=0V$ | - | - | ± 100 | nA |
| $R_{DS(ON)}^e$ | Drain-Source On-state Resistance | $V_{GS}=-10V, I_{DS}=-10A$ | - | 25 | 28 | m Ω |
| | | $T_J=125^\circ\text{C}$ | - | 21.9 | - | |
| | | $V_{GS}=-4.5V, I_{DS}=-5A$ | - | 34 | 40 | |
| Gfs | Forward Transconductance | $V_{DS}=5V, I_{DS}=5A$ | - | 13 | - | S |
| Diode Characteristics | | | | | | |
| V_{SD}^e | Diode Forward Voltage | $I_{SD}=-1A, V_{GS}=0V$ | - | -0.75 | -1 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD}=-10A, dI_{SD}/dt=100A/\mu s$ | - | 26 | - | ns |
| t_a | Charge Time | | - | 8 | - | |
| t_b | Discharge Time | | - | 18 | - | |
| Q_{rr} | Reverse Recovery Charge | | - | 7 | - | |
| Dynamic Characteristics^f | | | | | | |
| R_G | Gate Resistance | $V_{GS}=0V, V_{DS}=0V, f=1\text{MHz}$ | - | 3.4 | - | Ω |
| C_{iss} | Input Capacitance | $V_{GS}=0V,$ $V_{DS}=-15V,$ Frequency=1.0MHz | - | 1000 | - | pF |
| C_{oss} | Output Capacitance | | - | 210 | - | |
| C_{rss} | Reverse Transfer Capacitance | | - | 150 | - | |
| $t_{d(ON)}$ | Turn-on Delay Time | $V_{DD}=-15V, R_L=15\Omega,$ $I_{DS}=-1A, V_{GEN}=-10V,$ $R_G=6\Omega$ | - | 11 | - | ns |
| t_r | Turn-on Rise Time | | - | 12 | - | |
| $t_{d(OFF)}$ | Turn-off Delay Time | | - | 26 | - | |
| t_f | Turn-off Fall Time | | - | 12 | - | |
| Gate Charge Characteristics^f | | | | | | |
| Q_g | Total Gate Charge | $V_{DS}=-15V, V_{GS}=-4.5V,$ $I_{DS}=-10A$ | - | 9.6 | - | nC |
| Q_g | Total Gate Charge | $V_{DS}=-15V, V_{GS}=-10V,$ $I_{DS}=-10A$ | - | 21 | - | |
| Q_{gth} | Threshold Gate Charge | | - | 1.5 | - | |
| Q_{gs} | Gate-Source Charge | | - | 3.5 | - | |
| Q_{gd} | Gate-Drain Charge | | - | 5.9 | - | |

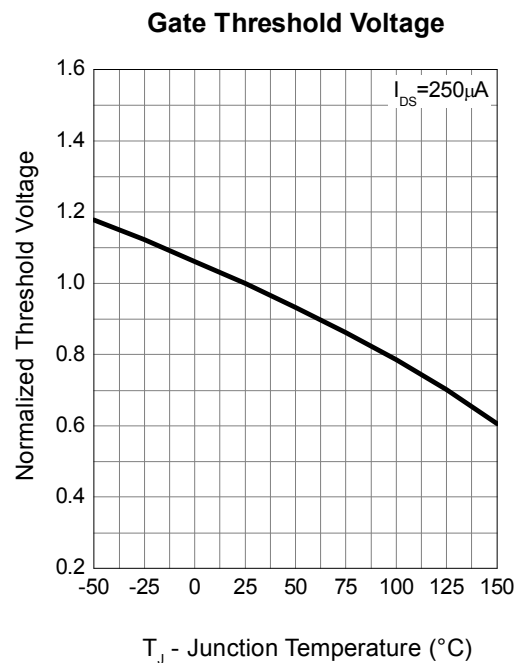
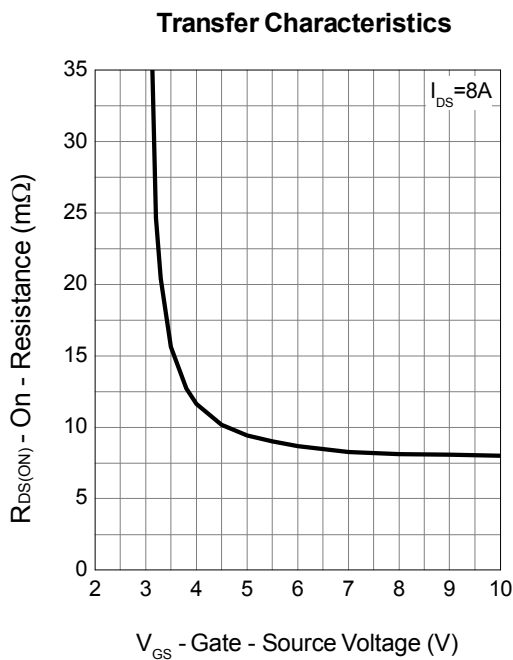
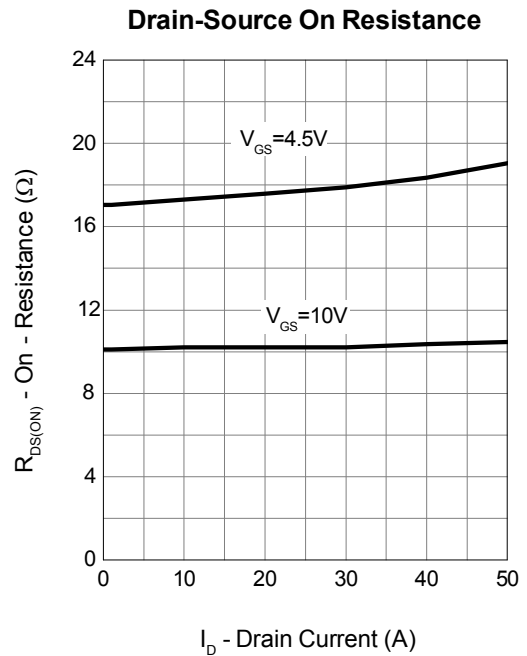
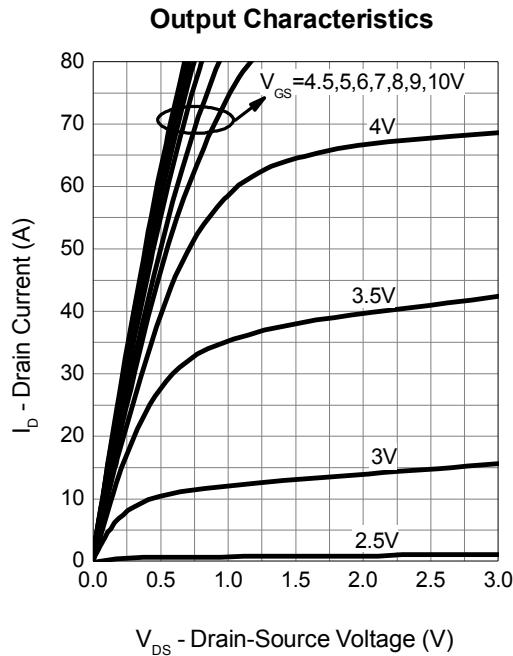
 Note e : Pulse test ; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

Note f : Guaranteed by design, not subject to production testing.

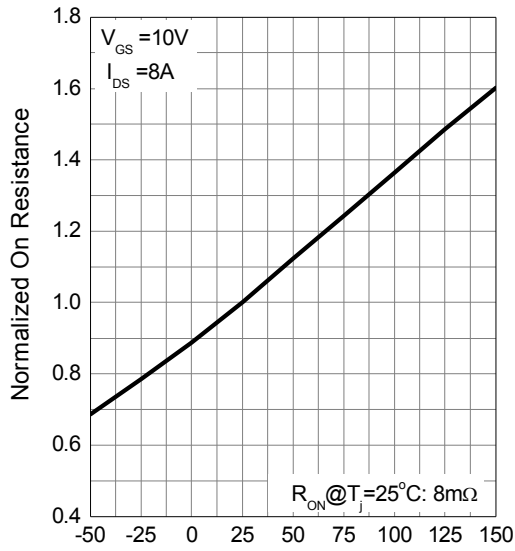
N Channel Typical Operating Characteristics

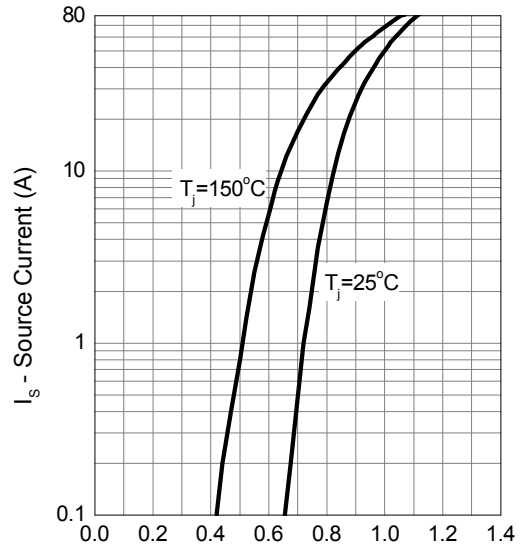


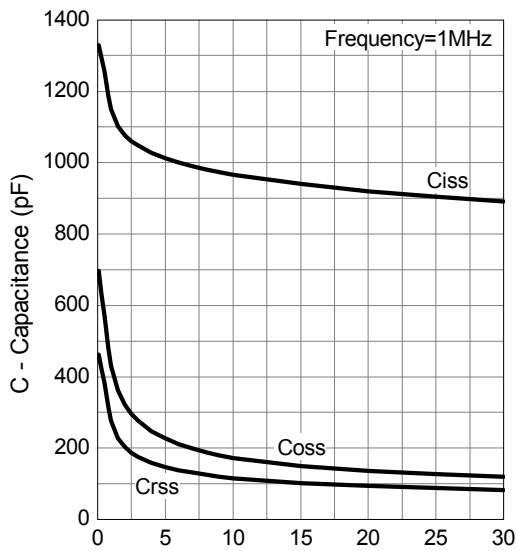
N Channel Typical Operating Characteristics (Cont.)

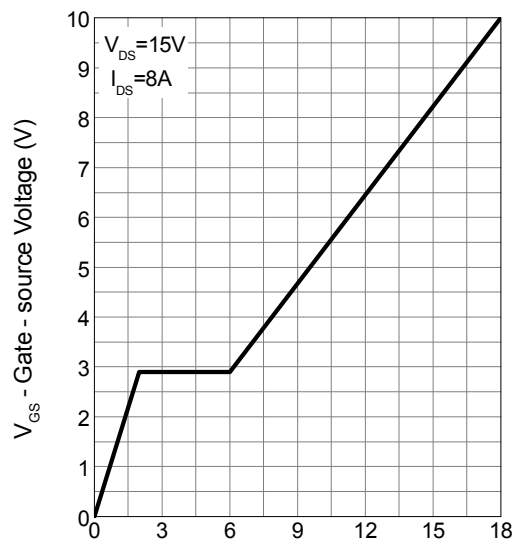


N Channel Typical Operating Characteristics (Cont.)

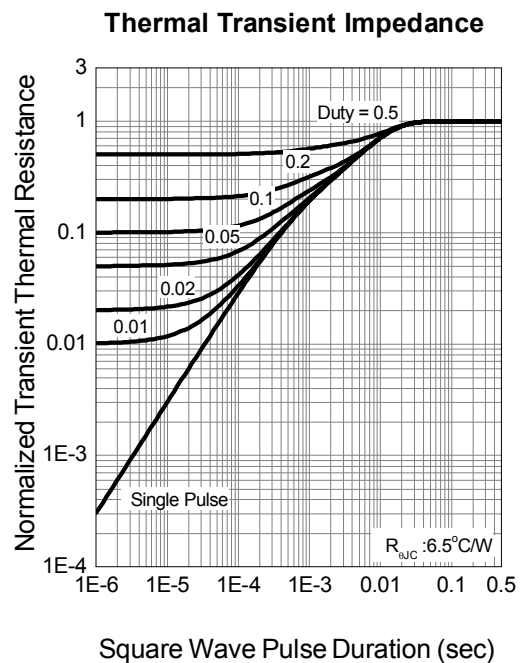
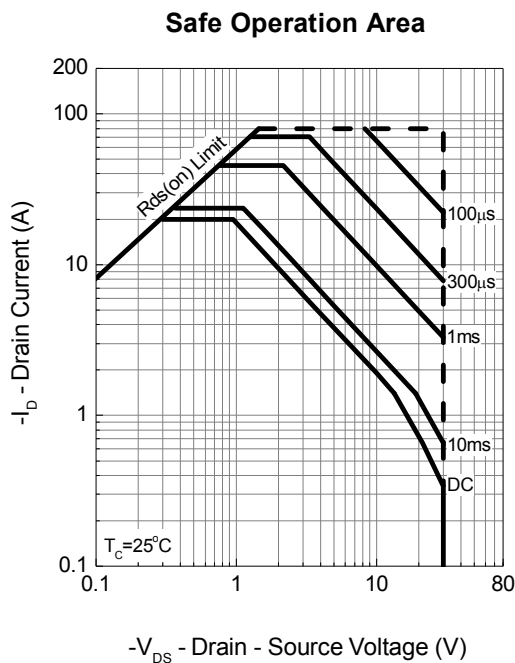
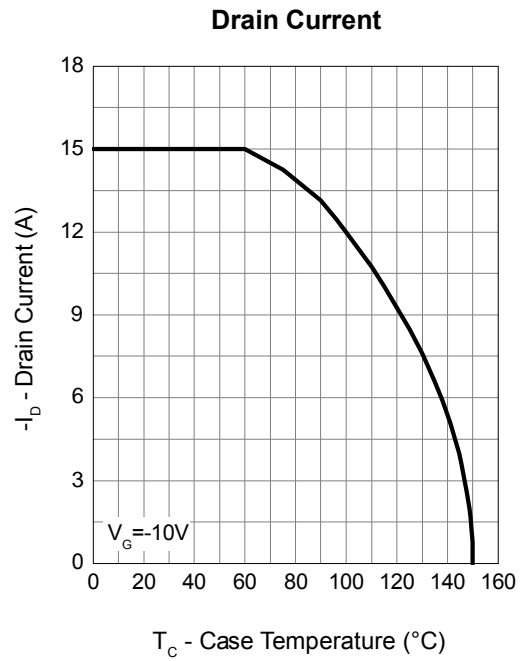
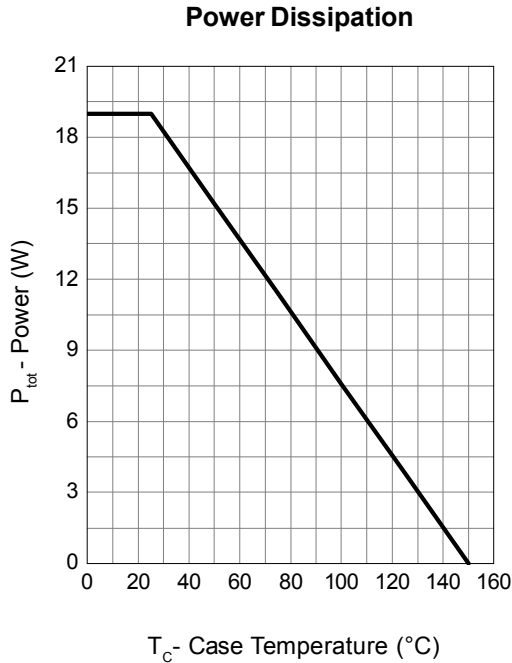
Drain-Source On Resistance

 T_j - Junction Temperature ($^\circ C$)

Source-Drain Diode Forward

 V_{SD} - Source - Drain Voltage (V)

Capacitance

 V_{DS} - Drain - Source Voltage (V)

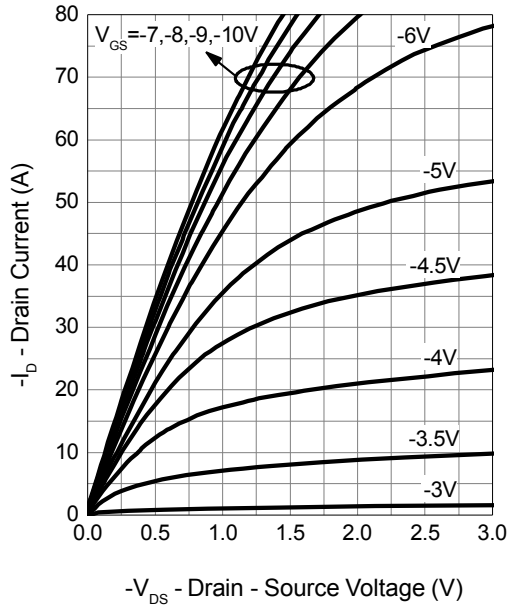
Gate Charge

 Q_g - Gate Charge (nC)

P Channel Typical Operating Characteristics

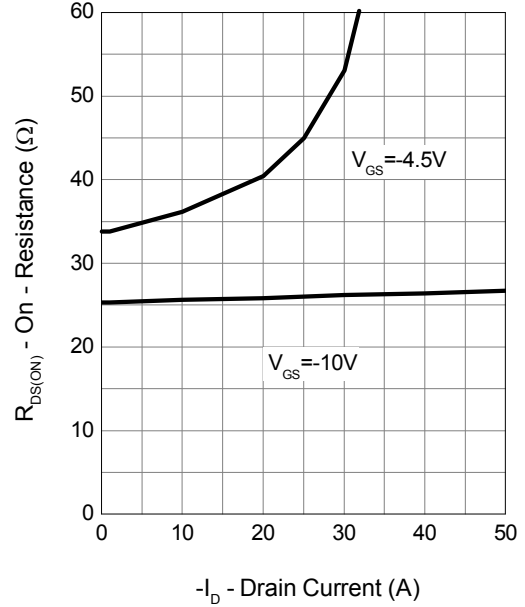


P Channel Typical Operating Characteristics (Cont.)

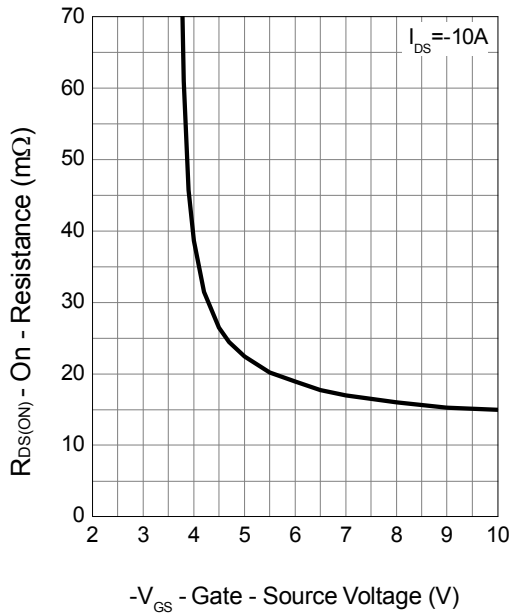
Output Characteristics



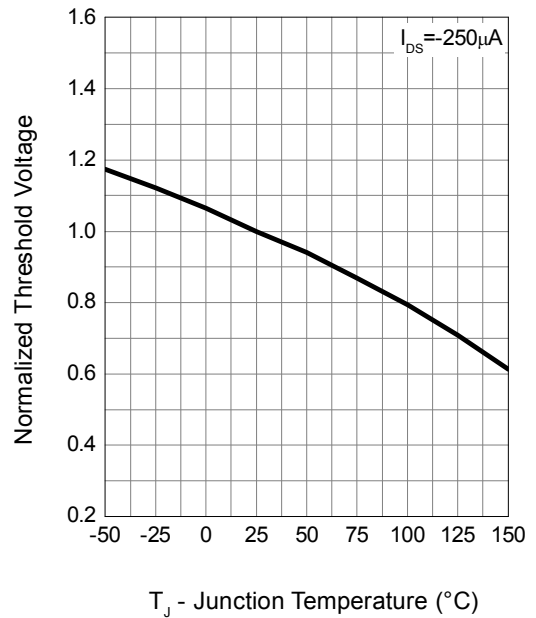
Drain-Source On Resistance



Transfer Characteristics

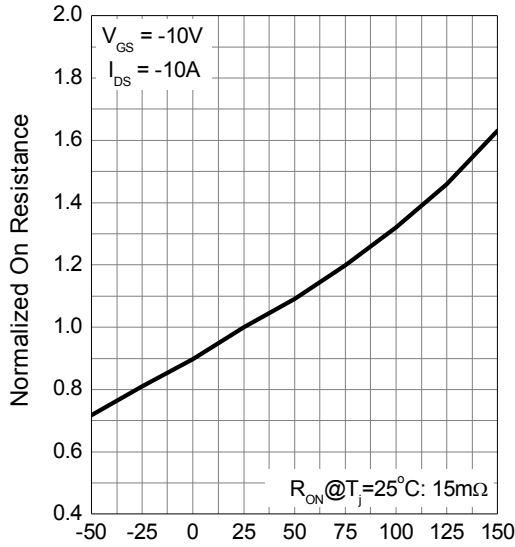


Gate Threshold Voltage



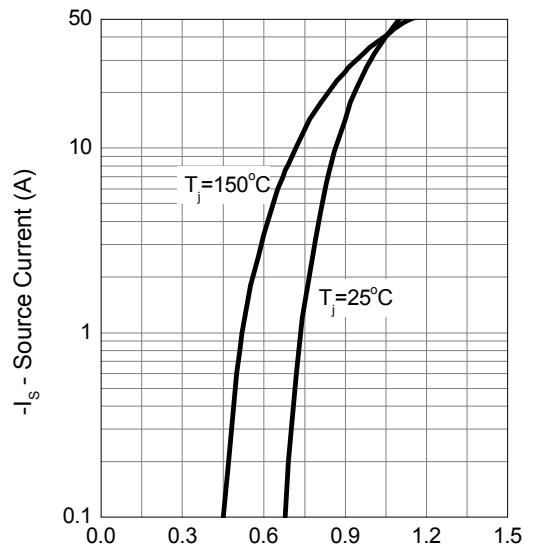
P Channel Typical Operating Characteristics (Cont.)

Drain-Source On Resistance



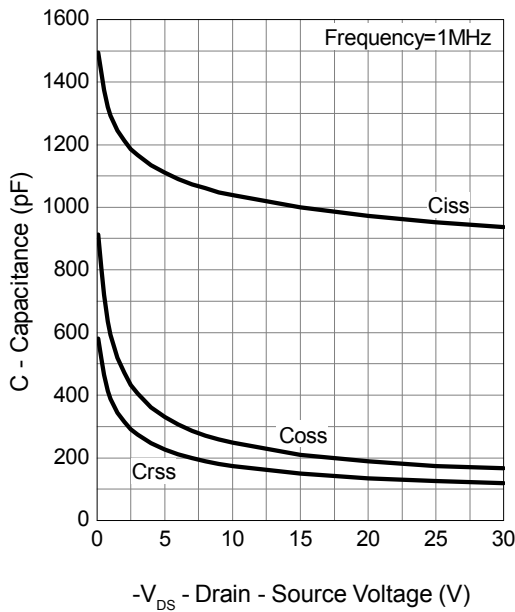
T_j - Junction Temperature ($^{\circ}\text{C}$)

Source-Drain Diode Forward



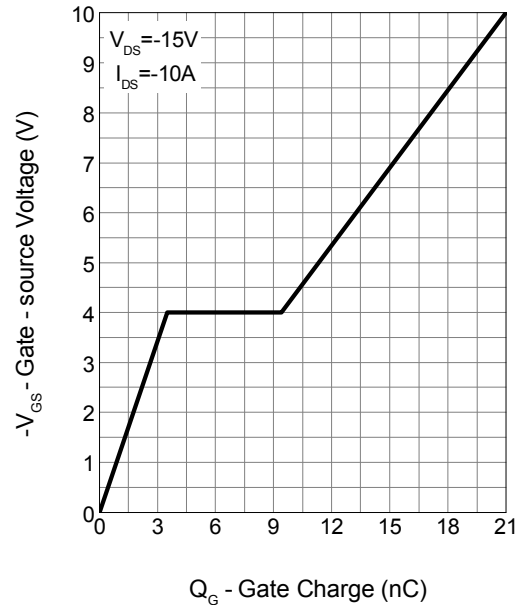
$-V_{SD}$ - Source - Drain Voltage (V)

Capacitance



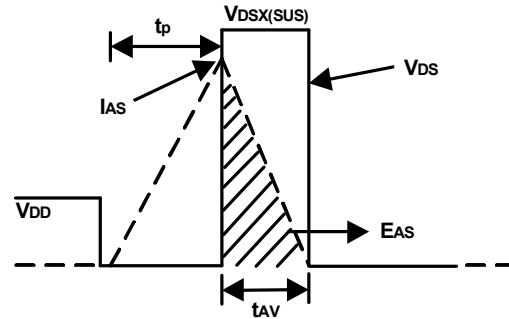
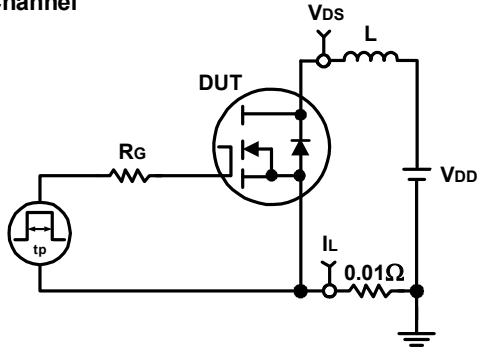
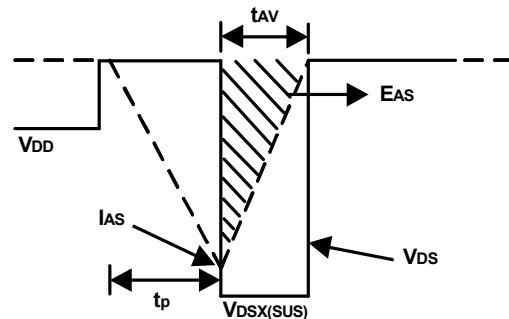
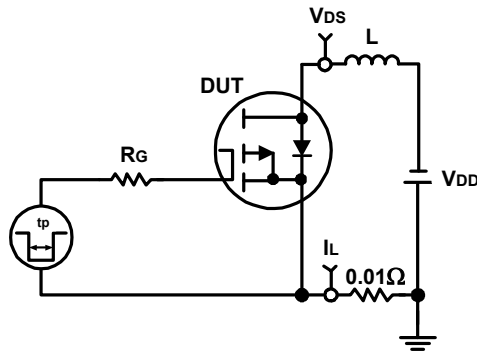
$-V_{DS}$ - Drain - Source Voltage (V)

Gate Charge

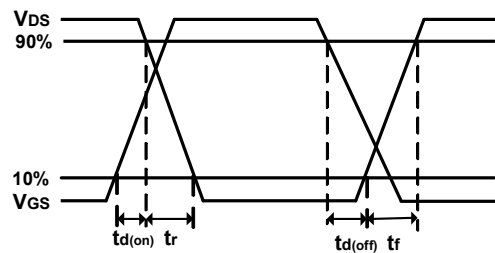
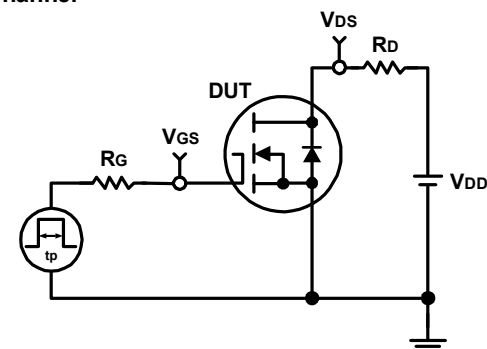
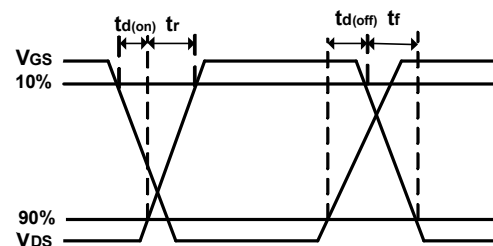
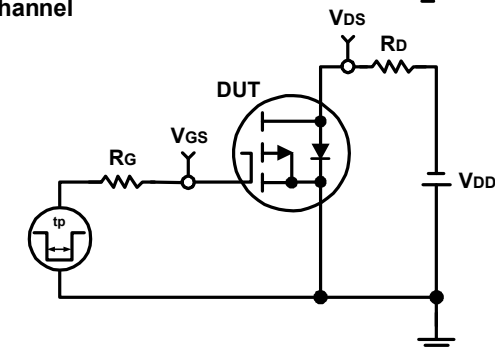


Q_g - Gate Charge (nC)

Avalanche Test Circuit and Waveforms

N Channel

P Channel


Switching Time Test Circuit and Waveforms

N Channel

P Channel


PDFN5*6-8L OUTLINE

